

EBVW025A0B Barracuda* Series; DC-DC Converter Power Modules

36-75V_{dc} Input; 12.0V_{dc}, 25.0A, 300W Output

RoHS Compliant



Distributed-power Open Standards Alliance

Applications

DATASHEET

- Distributed power architectures
- Intermediate bus voltage applications
- Telecommunications equipment
- Wireless Base stations
- Industrial equipment
- LANs/WANs
- Enterprise Networks
- Latest generation IC's (DSP, FPGA, ASIC) and Microprocessor powered applications

Description

The EBVW025A0B BARRACUDA series of dcdc converters are a new generation of DC/DC power modules designed to support 9.6-12V_{dc} intermediate bus applications where multiple low voltages are subsequently generated using point of load (POL) converters, as well as other application requiring a tightly regulated output voltage. The EBVW025A0B series operate from an input voltage range of 36 to 75V_{dc}, and provide up to 25A output current at output voltages from $6.0V_{dc}$ to $12.0V_{dc}$, and 300Woutput power from output voltages of 12.1V_{dc} to $13.2V_{dc}$ in a DOSA standard eighth brick. The converter incorporates digital control, synchronous rectification technology, and innovative packaging techniques to achieve efficiency reaching 95.4% peak at 12V_{dc} output. This leads to lower power dissipations such that for many applications a heat sink is not required. Standard features include on/off control, output overcurrent and over voltage protection, over temperature protection, input under and over voltage lockout.

Optional features include output voltage remote sense and trim from $6.0V_{dc}$ to $13.2V_{dc}$, passive droop paralleling, and base plate for heat sink or cold wall applications.

The output is fully isolated from the input, allowing versatile polarity configurations and grounding connections. Built-in filtering for both input and output minimizes the need for external filtering.

See footnotes on page no. 2



Features

- Compliant to RoHS EU Directive 2011/65/EU and amended Directive (EU) 2015/863. (-Z versions)
- Compliant to REACH Directive (EC) No 1907/2006
- Wide input voltage range: 20 to 30Vdc
- Output voltage programmable via external resistor: $5V_{dc}$ to $15V_{dc}$
- High efficiency modules (V $_{\rm IN}$ = 24V $_{\rm dc}$) 97% at 12V $_{\rm dc}$ full load
- Low output ripple and noise
- Monotonic start-up into pre-bias output
- Remote On/Off (Positive logic)
- Remote Sense

- Small size and low profile:
 50.8 mm x 12.7 mm x 8.1 mm (2.00 in x 0.50 in x 0.32 in)
- Constant switching frequency
- Wide operating temperature range (-40°C to 85°C)
- Over current and Over temperature protection (non- latching)
- ANSI/UL* 62368-1 and CAN/CSA† C22.2 No. 62368-1 Recognized, DIN VDE‡ 0868-1/A11:2017 (EN62368- 1:2014/A11:2017)
- ISO** 9001 and ISO 14001 certified manufacturing facilities

Options

- Negative Remote On/Off logic (1=option code, factory preferred)
- Auto-restart after fault shutdown (4=option code, factory preferred)
- Remote Sense and Output Voltage Trim (9=option code)
- Base plate option (-H=option code)
- Passive Droop Load Sharing (-P=option code)

Footnotes

- *Trademark of General Electric Company
- # UL is a registered trademark of Underwriters Laboratories, Inc.
- † CSA is a registered trademark of Canadian Standards Association.
- ‡ VDE is a trademark of Verband Deutscher Elektrotechniker e.V.
- § This product is intended for integration into end-user equipment. All of the required procedures of end-use equipment should be followed.
- lpha IEEE and 802 are registered trademarks of the Institute of Electrical and Electronics Engineers, Incorporated.
- ** ISO is a registered trademark of the International Organization of Standards.



Technical Specifications

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only, functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect the device reliability.

Parameter	Device	Symbol	Min	Max	Unit
Input Voltage*					
Continuous		V _{IN}	-0.3	75	V_{dc}
Operating transient ≤ 100mS Operating Input transient slew rate, 50VIN to 75VIN				100	V _{dc}
(Output may exceed regulation limits, no protective shutdowns shall activate, CO=220µF to CO, max)		-	-	10	V/µs
Non- operating continuous		VIN	80	100	V _{dc}
Operating Ambient Temperature	All	т.	(0	85	°C
(See Thermal Considerations section)	All	TA	-40	60	
Storage Temperature	All	T _{stg}	-55	125	°C
I/O Isolation Voltage (100% factory Hi-Pot tested)	All	-	-	2250	V _{dc}

* Input over voltage protection will shutdown the output voltage, when the input voltage exceeds threshold level.

Electrical Specifications

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions.

Parameter	Device	Symbol	Min	Тур	Max	Unit
Operating Input Voltage		V _{IN}	36	48	75	V _{dc}
Maximum Input Current (V _{IN} =0V to 75V, I ₀ =I _{0, max})		I _{IN,max}			9	A _{dc}
Input No Load Current (V _{IN} = V _{IN, nom} , I _O = 0, module enabled)	All	IN,No load	-			mA
Input Stand-by Current (V _{IN} = V _{IN, nom} , module disabled)	All	I _{IN,stand-by}			25	mA
External Input Capacitance	All		100	-	-	μF
Inrush Transient	All	l²t	-	-	1	A ² s
Input Terminal Ripple Current (Measured at module input pin with maximum specified input capacitance and < 500uH inductance between voltage sourceand input capacitance C _{IN} =220uF, 5Hz to 20MHz, V _{IN} = 48V, I _O = I _{Omax})	All		-	950	-	mA _{rms}
Input Reflected Ripple Current, peak-to-peak (5Hz to 20MHz, 12µH source impedance; Vıℕ= 48V, I₀= I₀max ; seeFigure 12)	All		-	24	-	mA _{p-p}
Input Ripple Rejection (120Hz)	All		-	50	-	dB

CAUTION: This power module is not internally fused. An input line fuse must always be used.

This power module can be used in a wide variety of applications, ranging from simple standalone operation to an integrated part of sophisticated power architecture. To preserve maximum flexibility, internal fusing is not included, however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a fast-acting fuse with a maximum rating of 15 A (see Safety Considerations section). Based on the information provided in this Data Sheet on inrush energy and maximum dc input current, the same type of fuse with a lower rating can be used. Refer to the fuse manufacturer's Data Sheet for further information.



Electrical Specifications (continued)

Parameter	Device	Symbol	Min	Тур	Max	Unit
Output Voltage Set-point			11.00		10.07	
(V _{IN} =V _{IN,nom} , I _O =12.5A, T _A =25°C)	All	V _{O, set}	11.97	12.00	12.03	V_{dc}
Output Voltage	All w/o -P	Vo	11.76	_	12.24	V _{dc}
(Over all operating input voltage(40V to 75V), resistive load,	-P Option	Vo	11.60	_	12.24	V _{dc}
and temperature conditions until end of life)		۷O	11.00		12.40	V dc
Output Voltage (V _{IN} =36V, T _A = 25°C)	All	Vo	10.8	_	-	Vdc
Output Regulation (V _{IN, min} =40V)	All w/o -P			0.2	_	% VO, set
Line (V _{IN} =V _{IN, min} to V _{IN, max})	All w/o -P		_	0.2	_	% VO, set
Load $(I_0=I_{0, min} \text{ to } I_{0, max})$	-P Option		_	0.5	_	% VO, set
Line (VIN=VIN, min to VIN, max)	-P Option			0.50		V _{dc}
Load ($I_0=I_{0, min}$ to $I_{0, max}$), Intentional Droop	All			2	_	% VO, set
Temperature (TA = -40°C to +85°C)				2		70 VO, Set
Output Ripple and Noise on nominal output						
$(V_{IN}=V_{IN, nom} \text{ and } I_O=I_{O, min} \text{ to } I_{O, max}$ tested with a 1.0 μ F						
ceramic, 10 μ F aluminum and 220 μ F polymer capacitor						
across the load.)						
RMS (5Hz to 20MHz bandwidth)	All		-	70	-	mV _{rms}
Peak-to-Peak (5Hz to 20MHz bandwidth)	All		-	200	-	mV_{pk-pk}
External Output Capacitance	All	Co	220	_	10,000	μF
Output Current	All	lo	0		25	Adc
Output Current Limit Inception	All	l _{o,min}	27.5	30	-	Adc
Efficiency (VIN=VIN nom, TA=25°C, VO= VO,set)						
I ₀ =100% IO, max	All	η		94.7		%
I ₀ =40% to 80% IO, max	All	η		95.2		%
Switching Frequency (primary MOSFETs)(Output Ripple 2X switching frequency)		f _{sw}		150		kHz
Dynamic Load Response						
dlo/dt=1A/10ms; Vin=Vinnom; TA=25°C; (Tested with a 10µF						
ceramic and 3x 470µF polymer capacitor across the load.)					
Load Change from I_{\odot} = 50% to 75% of $I_{\odot,max}$						
Peak Deviation		V _{pk}	-	750	-	mV _{pk}
Settling Time (V_{\circ} <10% peak deviation)	All	ts	-	2	-	ms
Load Change from $I_0 = 75\%$ to 50% of $I_{0,max}$						
Peak Deviation			-	750	-	m\/
Settling Time (V $_{\circ}$ <10% peak deviation)	All	V _{pk}	-	2	-	mV _{pk}
		ts				ms



Isolation Specifications

Parameter	Symbol	Min	Тур	Max	Unit
Isolation Capacitance	C _{iso}	-	1000	-	рF
Isolation Resistance	R _{iso}	10	-	-	MΩ

General Specifications

Parameter	Device	Symbol	Тур	Unit
Calculated Reliability based upon Telcordia SR-332				
$(I_{O}=80\%I_{O, max}, T_{A}=40^{\circ}C, Airflow = 200 \text{ lfm}), 90\% \text{ confidence})$				
Issue 3: Method I, Case 3	All	MTBF FIT	11,795,001 84.8	Hours 10º/Hours
Issue 2: Method I, Case 1	All	MTBF FIT	3,933,515 254.2	Hours 10º/Hours
Weight – Open Frame			29.5 (1.04)	g (oz.)
Weight – with Baseplate option			39.0 (1.38)	g (oz.)



Feature Specifications

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions. See Feature Descriptions for additional information.

Parameter	Device	Symbol	Min	Тур	Max	Unit
Remote On/Off Signal Interface (V _{IN} =V _{IN, min} to V _{IN, max} , Signal referenced to V _{IN} - terminal) Negative Logic: device code suffix "1" Logic Low = module On, Logic High = module Off Positive Logic: No device code suffix required						
Logic Low = module Off, Logic High = module On Logic Low Specification On/Off Thresholds: Remote On/Off Current – Logic LowLogic Low Voltage	All All	I _{on/off} V _{on/off}	280 -0.3	-	310 0.8	μΑ V _{dc}
Logic High Voltage – (Typ = Open Collector) Logic High maximum allowable leakage current(Von/off = 2.0V) Maximum voltage allowed on On/Off pin	All All All	Von/off I _{on/off} Von/off	2.0	-	14.5 10 14.5	V _{dc} µA V _{dc}
Turn-on Delay and Rise Time (I _o =I _{o, max})	All w/o -P	Tdelay, Enable with	_	-	160	ms
Tdelay=Time until VO = 10% of VO,set from either application of Vin with Remote On/Off set to On (Enable with Vin); or operation of Remote On/Off from Off to On with Vin already applied for at least	All w/o-P	Vin T _{delay, Enable with} on/off	-	-	40 180*	ms
 150 milli-seconds (Enable with on/off). * Increased Tdelay due to startup for parallel modules. 	w/ -P w/ -P	Tdelay,Enable with Vin Tdelay, Enable with on/off	-	-	40*	ms ms
Trise=Time for VO to rise from 10% to 90% of VO,set, For CO >5000uF, IO must be < 50% IO, max during Trise. * Increased Trise when Vo exists at startup for parallel modules.	All w/o -P w/ -P	T _{rise}	-	-	40 300*	ms ms
Load Sharing Current Balance (difference in output current across all modules with outputs in parallel, no load to full load)	-P Option	l _{diff}			3	A
Prebias Output Load Performance: Back Bias current sunk by output during start-up Back Bias current sunk by output during shut-down	All		-	-	50 50	mA mA
Remote Sense Range	All w/ "9" option	V _{Sense}	-	_	0.5	V _{dc}
Output Voltage Adjustment range	All w/ "9" option	V _{O, set}	6.0	15	13.2	V _{dc}
Output Overvoltage Protection	All	V _{O,limit}	14.5		17.0	V _{dc}
Overtemperature Protection (See Feature Descriptions)	All	T _{ref}	-	140	-	°C
Input Undervoltage Lockout						
Turn-on Threshold			34	35	36	V_{dc}
Turn-off Threshold			32	33.5	34.5	V_{dc}
Input Overvoltage Lockout						
Turn-off Threshold			83	85	86	V_{dc}
Turn-on Threshold			76	79	-	V_{dc}



Characteristic Curves

The following figures provide typical characteristics for the EBVW025A0B (12V, 25A) at 25°C. The figures are identical for either positive or negative Remote On/Off logic.

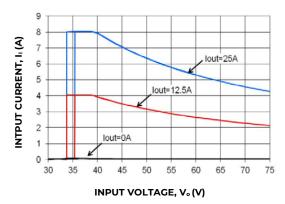


Figure 1. Typical Input Characteristic at Room Temperature

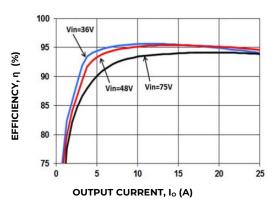


Figure 2. Typical Converter Efficiency Vs. Output current at

Room Temperature.

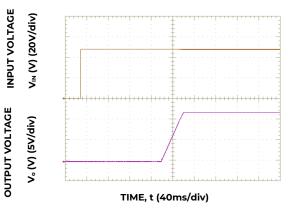


Figure 3. Typical Start-Up Using Vin with Remote On/Off enabled, negative logic version shown.

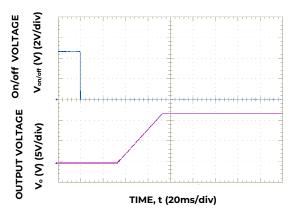
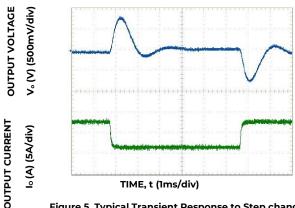
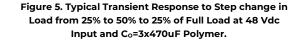


Figure 4. Typical Start-Up Using Remote On/Off with V_{in} applied, negative logic version shown.





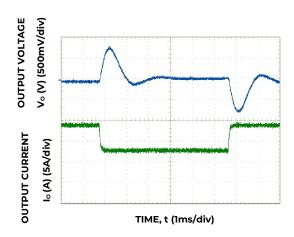
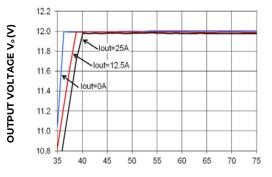


Figure 6. Typical Transient Response to Step Change in Load from 50% to 75% to 50% of Full Load at 48 V_dc Input and $C_0=3x470$ uF Polymer.



Characteristic Curves (continue)



INPUT VOLTAGE V_{in} (V)

Figure 7. Typical Output Voltage Regulation vs. Input Voltage at Room Temperature.

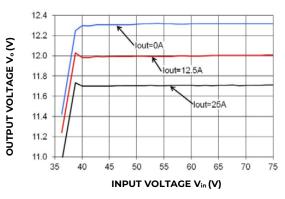


Figure 10. Typical Output Voltage Regulation vs. Input Voltage for the –P Version at Room Temperature.

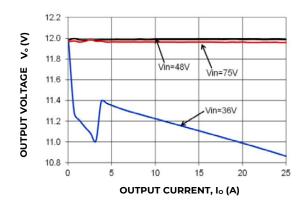
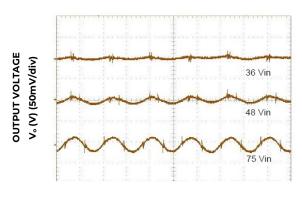


Figure 8. Typical Output Voltage Regulation vs. Output Current at Room Temperature.



TIME, t (2µs/div)

Figure 9. Typical Output Ripple and Noise at Room Temperature Io = I_{o,max} and and Comin.

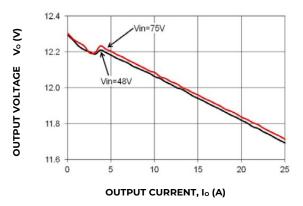


Figure 11. Typical Output Voltage Regulation vs. Output Current for the –P Version at Room Temperature.



Test Considerations

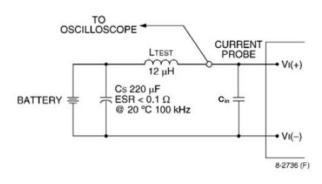
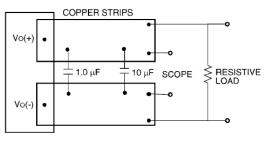


Figure 12. Input Reflected Ripple Current Test Setup.

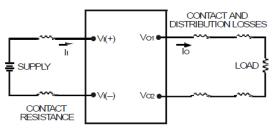
Note: Measure input reflected-ripple current with a simulated source inductance (LTEST) of 12 μ H. Capacitor C_s offsets possible battery impedance. Measure current as shown above.

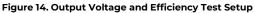


8-3299 (F)



Note: Use a 1.0 μ F ceramic capacitor and a 10 μ F aluminum or tantalum capacitor. Scope measurement should be made using a BNC socket. Position the load between 51 mm and 76 mm (2 in. and 3 in.) from the module.





Note: All measurements are taken at the module terminals. When socketing, place Kelvin connections at module terminals to avoid measurement errors due to socket contact resistance.

$$\eta = \left(\frac{[V_0(+) - V_0(-)]I_0}{[V_i(+) - V_i(-)]I_1}\right) x100$$

Design Considerations

Input Source Impedance

The power module should be connected to a low ac-impedance source. A highly inductive source impedance can affect the stability of the power module. For the test configuration in Figure 12, a 220μ F electrolytic capacitor, C_{in}, (ESR<0.7 Ω at 100kHz), mounted close to the power module helps ensure the stability of the unit. If the module is subjected to rapid on/off cycles, a 330 μ F input capacitor is required. Consult the factory for further application guidelines.

Safety Considerations

For safety agency approval the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards, i.e., UL ANSI/UL* 62368-1 and CAN/CSA+ C22.2 No. 62368-1 Recognized, DIN VDE 0868-1/ All:2017 (EN62368-1:2014/All:2017)

If the input source is non-SELV (ELV or a hazardous voltage greater than 60 V_{dc} and less than or equal to $75V_{dc}$), for the module's output to be considered as meeting the requirements for safety extra-low voltage (SELV) or ES1, all of the following must be true:

- The input source is to be provided with reinforced insulation from any other hazardous voltages, including the ac mains.
- One V_{IN} pin and one V_{OUT} pin are to be grounded, or both the input and output pins are to be kept floating.
- The input pins of the module are not operator accessible.
- Another SELV or ES1 reliability test is conducted on the whole system (combination of supply source and subject module), as required by the safety agencies, to verify that under a single fault, hazardous voltages do not appear at the module's output.

Note: Do not ground either of the input pins of the module without grounding one of the output pins. This may allow a non-SELV/ESI voltage to appear between the output pins and ground.

The power module has safety extra-low voltage (SELV) or ES1 outputs when all inputs are SELV or ES1.



The input to these units is to be provided with a maximum 15 A fast-acting (or time-delay) fuse in the unearthed lead.

The power module has internally generated voltages exceeding safety extra-low voltage. Consideration should be taken to restrict operator accessibility.

Feature Description

Overcurrent Protection

To provide protection in a fault output overload condition, the module is equipped with internal current-limiting circuitry and can endure current limiting continuously. If the overcurrent condition causes the output voltage to fall greater than 4.0V from V_{oset}, the module will shut down and remain latched off. The overcurrent latch is reset by either cycling the input power or by toggling the on/off pin for one second. If the output overload condition still exists when the module restarts, it will shut down again. This operation will continue indefinitely until the overcurrent condition is corrected.

A factory configured auto-restart option (with overcurrent and overvoltage auto-restart managed as a group) is also available. An auto-restart feature continually attempts to restore the operation until fault condition is cleared.

Remote On/Off

The module contains a standard on/off control circuit reference to the V_{IN}(-) terminal. Two factory configured remote on/off logic options are available. Positive logic remote on/off turns the module on during a logic-high voltage on the ON/OFF pin, and off during a logic low. Negative logic remote on/off turns the module off during a logic high, and on during a logic low. Negative logic, device code suffix "1," is the factorypreferred configuration. The On/Off circuit is powered from an internal bias supply, derived from the input voltage terminals. To turn the power module on and off, the user must supply a switch to control the voltage between the On/Off terminal and the $V_{IN}(-)$ terminal (Von/off). The switch can be an open collector or equivalent (see Figure 15). A logic low is V_{on/off} = -0.3V to 0.8V. The typical Ion/off during a logic low (V_{in}=48V, On/Off Terminal=0.3V) is 147µA. The switch should maintain a logic-low voltage while sinking 310µA. During a logic high, the maximum Von/off generated by the power module is 8.2V. The maximum allowable leakage current of the switch at $V_{on/off}$ = 2.0V is 10µA.

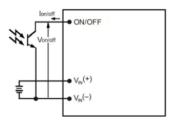


Figure 15. Remote On/Off Implementation.

If using an external voltage source, the maximum voltage $V_{\text{on/off}}$ on the pin is 14.5V with respect to the V_{IN} (-) terminal.

If not using the remote on/off feature, perform one of the following to turn the unit on:

For negative logic, short ON/OFF pin to V_{IN} (-).

For positive logic: leave ON/OFF pin open.

Output Overvoltage Protection

The module contains circuitry to detect and respond to output overvoltage conditions. If the overvoltage condition causes the output voltage to rise above the limit in the Specifications

Table, the module will shut down and remain latched off. The overvoltage latch is reset by either cycling the input power, or by toggling the on/off pin for one second. If the output overvoltage condition still exists when the module restarts, it will shut down again. This operation will continue indefinitely until the overvoltage condition is corrected.

A factory configured auto-restart option (with overcurrent and overvoltage auto-restart managed as a group) is also available. An auto-restart feature continually attempts to restore the operation until fault condition is cleared.

Overtemperature Protection

These modules feature an overtemperature protection circuit to safeguard against thermal damage. The circuit shuts down the module when the maximum device reference temperature is exceeded. The module will automatically restart once the reference temperature cools by ~25°C.

Input Under/Over voltage Lockout

At input voltages above or below the input under/over voltage lockout limits, module operation is disabled. The module will begin to operate when the input voltage level changes to within the under and overvoltage lockout limits.



Feature Description (continued)

Load Sharing (-P Option Code)

For higher power requirements, the EBVW025 power module offers an optional feature for parallel operation. This feature provides a precise forced output voltage load regulation droop characteristic. The output set point and droop slope are factory calibrated to insure optimum matching of multiple modules' load regulation characteristics. To implement load sharing, the following requirements should be followed:

- The V_{OUT}(+) and V_{OUT}(-) pins of all parallel modules must be connected together. Balance the trace resistance for each module's path to the output power planes, to insure best load sharing and operating temperature balance.
- V_{IN} must remain between 40V_{dc} and 75V_{dc} for droop sharing to be functional.
- It is permissible to use a common Remote On/Off signal to start all modules in parallel.
- These modules contain means to block reverse current flow upon start-up, when output voltage is present from other parallel modules, thus eliminating the requirement for external output ORing devices. Modules with the –P option will self determine the presence of voltage on the output from other operating modules, and automatically increase its Turn On delay, T_{delay}, as specified in the Feature Specifications Table.
- When parallel modules startup into a pre-biased output, e.g. partially discharged output capacitance, the Trise is automatically increased, as specified in the Feature Specifications Table, to insure graceful startup.
- Insure that the load is <50% I_{O,MAX} (for a single module) until all parallel modules have started (load full start > module T_{delay} time max + T_{rise} time).
- If fault tolerance is desired in parallel applications, output ORing devices should be used to prevent a single module failure from collapsing the load bus.
- Modules with –P option cannot include the "9" option.

Remote Sense ("9" Option Code)

Remote sense minimizes the effects of distribution losses by regulating the voltage at the remote-sense connections (See Figure 16). The voltage between the remote-sense pins and the output terminals must not exceed the output voltage sense range given in the Feature Specifications table:

 $[VO(+) - VO(-)] - [SENSE(+) - SENSE(-)] \le 0.5 V$

The amount of power delivered by the module is defined as the voltage at the output terminals multiplied by the output current. When using remote sense and trim, the output voltage of the module can be increased, which at the same output current would increase the power output of the module. Care should be taken to ensure that the maximum output power of the module remains at or below the maximum rated power (Maximum rated power = $V_{o,set} \times I_{o,max}$).

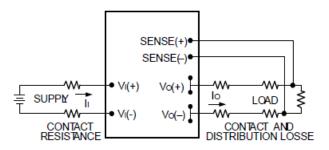


Figure 16. Circuit Configuration for remote sense.

Trim, Output Voltage Programming ("9" Option Code)

Trimming allows the output voltage set point to be increased or decreased; this is accomplished by connecting an external resistor between the TRIM pin and either the $V_0(+)$ pin or the $V_0(-)$ pin.

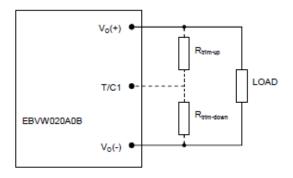


Figure 17. Circuit Configuration to Trim Output Voltage

Connecting an external resistor ($R_{trim-down}$) between the T/Cl pin and the Vo(-) (or Sense(-)) pin decreases the output voltage set point. To maintain set point accuracy, the trim resistor tolerance should be ±1.0%.

The following equation determines the required external resistor value to obtain a percentage output voltage change of

Δ%



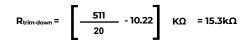


Feature Description (continued)

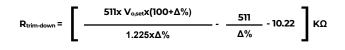
Where



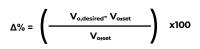
For example, to trim-down the output voltage of the module by 20% to 9.6V, Rtrim-down is calculated as follows:



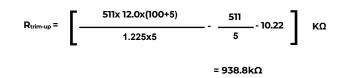
Connecting an external resistor (Rtrim-up) between the T/Cl pin and the VO(+) (or Sense (+)) pin increases the output voltage set point. The following equations determine the required external resistor value to obtain a percentage output voltage change of Δ %:



Where,



For example, to trim-up the output voltage of the module by 5% to 12.6V, R_{trim-up} is calculated is as follows:



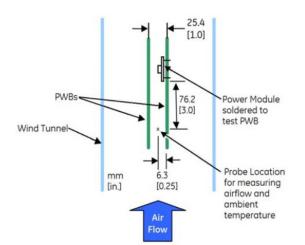
The voltage between the Vo(+) and Vo(–) terminals must not exceed the minimum output overvoltage protection value shown in the Feature Specifications table. This limit includes any increase in voltage due to remote-sense compensation and output voltage setpoint adjustment trim. Although the output voltage can be increased by both the remote sense and by the trim, the maximum increase for the output voltage is not the sum of both. The maximum increase is the larger of either the remote sense or the trim. The amount of power delivered by the module is defined as the voltage at the output terminals multiplied by the output current. When using remote sense and trim, the output voltage of the module can be increased, which at the same output current would increase the power output of the module. Care should be taken to ensure that the maximum output power of the module remains at or below the maximum rated power (Maximum rated power = $V_{0,set} \times I_{0,max}$). Modules with "9" option cannot include the –P option.

Thermal Considerations

The power modules operate in a variety of thermal environments and sufficient cooling should be provided to help ensure reliable operation.

Thermal considerations include ambient temperature, airflow, module power dissipation, and the need for increased reliability. A reduction in the operating temperature of the module will result in an increase in reliability.

The thermal data presented here is based on physical measurements taken in a wind tunnel, using automated thermo-couple instrumentation to monitor key component temperatures: FETs, diodes, control ICs, magnetic cores, ceramic capacitors, opto-isolators, and module pwb conductors, while controlling the ambient airflow rate and temperature. For a given airflow and ambient temperature, the module output power is increased, until one (or more) of the components reaches its maximum derated operating temperature, as defined in IPC-9592. This procedure is then repeated for a different airflow or ambient temperature until a family of module output derating curves is obtained.





Feature Description (continued)

Heat-dissipating components are mounted on the top side of Heat-dissipating components are mounted on the top side of the module. Heat is removed by conduction, convection and radiation to the surrounding environment. Proper cooling can be verified by measuring the thermal reference temperature (TH_x). Peak temperature (TH_x) occurs at the position indicated in Figure 18 and 19. For reliable operation this temperature should not exceed the listed temperature threshold.

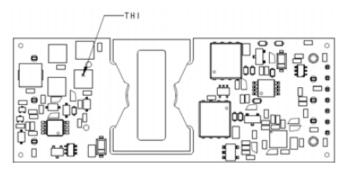
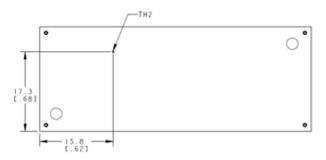
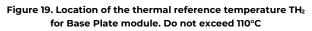


Figure 18. Location of the thermal reference temperature TH. Do not exceed 113°C.





The output power of the module should not exceed the rated power for the module as listed in the Ordering Information table.

Although the maximum temperature of the power modules is THx, you can limit this temperature to a lower value for extremely high reliability.

Please refer to the Application Note "Thermal Characterization Process For Open-Frame Board-Mounted Power Modules" for a detailed discussion of thermal aspects including maximum device temperatures.

Heat Transfer via Convection

Increased airflow over the module enhances the heat transfer via convection. The thermal derating of figures 20 through 22 show the maximum output current that can be delivered by each module in the indicated orientation without exceeding the maximum TH_x temperature versus local ambient temperature (T_A) for air flows of, Natural Convection, 1 m/s (200 ft./min), 2 m/s (400 ft./min).

The use of Figures 20 is shown in the following example:

Example

What is the minimum airflow necessary for a EBVW025A0B operating at V_1 = 48 V, an output current of 14A, and a maximum ambient temperature of 70 °C in transverse orientation.

Solution:

Given: V_{in}= 48V, I₀ = 14A, T_A = 70°C

Determine required airflow (V) (Use Figure 20):

V = 200LFM or greater.

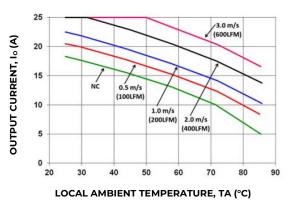


Figure 20. Output Current Derating for the Open Frame EBVW025A0B in the Transverse Orientation; Airflow Direction from Vin(-) to Vin(+); V_{in} = 48V.

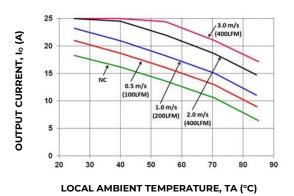
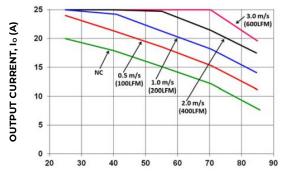


Figure 21. Output Current Derating for the Base Plate EBVW025A0Bxx-H in the Transverse Orientation; Airflow Direction from Vin(-) to Vin(+); Vin = 48V





LOCAL AMBIENT TEMPERATURE, TA (°C)

Figure 22. Output Current Derating for the Base Plate EBVW025A0Bxx-H and 0.25" heat sink in the Transverse Orientation; Airflow Airflow Direction from Vin(-) to Vin(+); V_{in} = 48V.

Layout Considerations

The EBVW025 power module series are low profile in order to be used in fine pitch system card architectures. As such, component clearance between the bottom of the power module and the mounting board is limited. Avoid placing copper areas on the outer layer directly underneath the power module. Also avoid placing via interconnects underneath the power module.

For additional layout guide-lines, refer to FLT007A0Z Data Sheet.

Through-Hole Lead-Free Soldering Information

The RoHS-compliant, Z version, through-hole products use the SAC (Sn/Ag/Cu) Pb-free solder and RoHScompliant components. The non-Z version products use lead-tin (Pb/Sn) solder and RoHS-compliant components. Both version modules are designed to be processed through single or dual wave soldering machines. The pins have an RoHS-compliant, pure tin finish that is compatible with both Pb and Pb-free wave soldering processes. A maximum preheat rate of 3°C/s is suggested. The wave preheat process should be such that the temperature of the power module board is kept below 210°C. For Pb solder, the recommended pot temperature is 260°C, while the Pb -free solder pot is 270°C max. Not all RoHS- compliant through-hole products can be processed with pastethrough-hole Pb or Pb-free reflow process. If additional information is needed, please consult with your OmniOn representative for more details.

Reflow Lead-Free Soldering Information

The RoHS-compliant through-hole products can be processed with the following paste-through-hole Pb or Pb-free reflow process.

Max. sustain temperature :

245°C (J-STD-020C Table 4-2: Packaging Thickness>=2.5mm / Volume > 2000mm³),

Peak temperature over 245°C is not suggested due to the potential reliability risk of components under continuous high- temperature.

Min. sustain duration above 217°C : 90 seconds Min. sustain duration above 180°C : 150 seconds Max. heat up rate: 3°C/sec

Max. cool down rate: 4°C/sec

In compliance with JEDEC J-STD-020C spec for 2 times reflow requirement.

Pb-free Reflow Profile

BMP module will comply with J-STD-020 Rev. C (Moisture/Reflow Sensitivity Classification for

Nonhermetic Solid State Surface Mount Devices) for both Pb- free solder profiles and MSL classification

procedures. BMP will comply with JEDEC J-STD-020C specification for 3 times reflow requirement. The suggested Pb-free solder paste is Sn/Ag/Cu (SAC). The recommended linear reflow profile using Sn/Ag/Cu solder is shown in Figure 23.

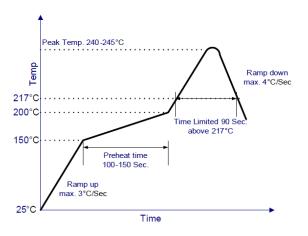


Figure 23. Recommended linear reflow profile using Sn/Ag/Cu solder.

MSL Rating

The EBVW025A0BA modules have a MSL rating as indicated in the Device Codes table, last page of this document.



Storage and Handling

The recommended storage environment and handling procedures for moisture-sensitive surface mount packages is detailed in J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices).

Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of \leq 30°C and 60% relative humidity varies according to the MSL rating (see J-STD-025A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions: < 40°C, < 90% relative humidity.

Post Solder Cleaning and Drying Considerations

Post solder cleaning is usually the final circuit-board assembly process prior to electrical board testing. The result of inadequate cleaning and drying can affect both the reliability of a power module and the testability of the finished circuit-board assembly. For guidance on appropriate soldering, cleaning and drying procedures, refer to OmniOn Board Mounted Power Modules: Soldering and Cleaning Application Note (AP01-056EPS).



EMC Considerations

The circuit and plots in Figure 24 shows a suggested configuration to meet the conducted emission limits of EN55022 Class B. For further information on designing for EMC compliance, please refer to the FLT007A0 data sheet.

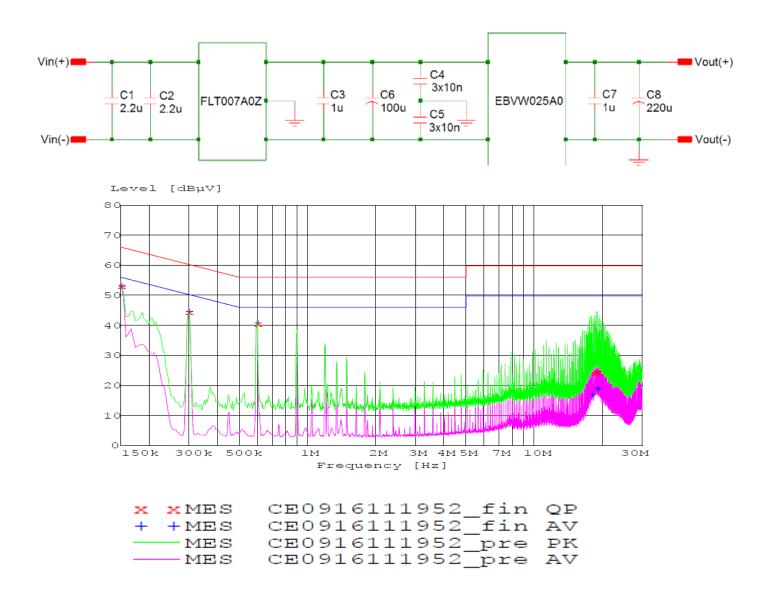


Figure 24. EMC Considerations.



Packaging Details

All versions of the EBVW025A0B are supplied as standard in the plastic trays shown in Figure 25. Each tray contains a total of 18 power modules. The trays are self-stacking and each shipping box for the EBVW025A0B module contains 2 full trays plus one empty hold-down tray giving a total number of 36 power modules.

Tray Specification

Material Max surface resistivity Capacity Min order quantity PET (1mm) 109 -1011Ω/PET Color Clear 18 power modules 36 pcs (1 box of 2 full trays + 1 empty top tray)

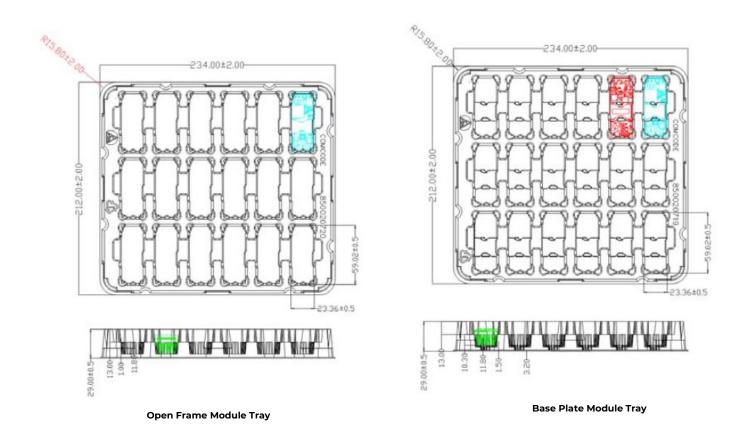


Figure 25. EBVW025 Packaging Tray



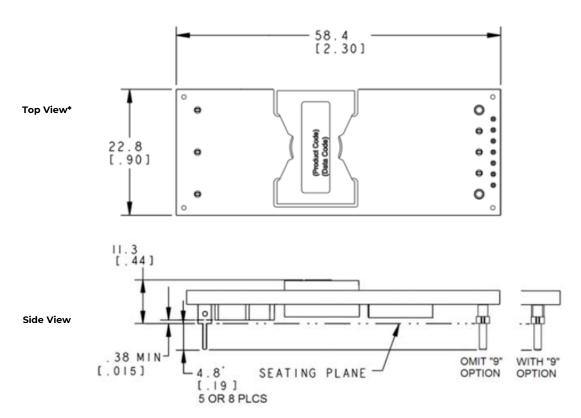
Mechanical Outline for EBVW025A0B Through-hole Module

Dimensions are in millimeters and (inches).

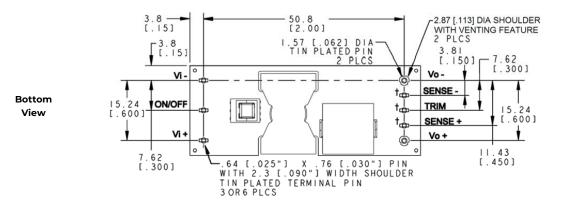
Tolerances: x.x mm ±0.5 mm (x.xx in. ± 0.02 in.) [Unless otherwise indicated]

x.xx mm ± 0.25 mm (x.xxx in ± 0.010 in.)

Top side label includes OmniOn name, product designation and date code.



*For optional pin lengths, see Table 2, Device Coding Scheme and Options



Pin	Function
1	∨i(+)
2	ON/OFF
3	∨i(-)
4	Vo(-)
5†	SENSE(-)
6†	TRIM
7†	SENSE(+)
8	Vo(+)

† - Optional Pins, when including "9" Option, See Table 2

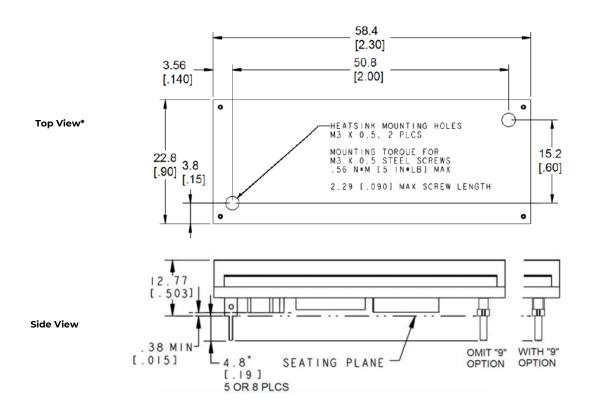


Mechanical Outline for EBVW025A0B–H (Baseplate version) Through-hole Module

Dimensions are in millimeters and (inches).

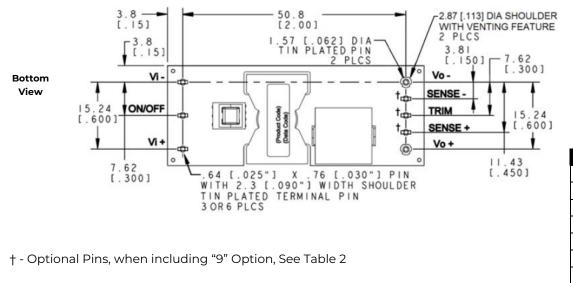
Tolerances: x.x mm ±0.5 mm (x.xx in. ± 0.02 in.) [Unless otherwise indicated]

x.xx mm ± 0.25 mm (x.xxx in ± 0.010 in.)



*For optional pin lengths, see Table 2, Device Coding Scheme and Options

*Bottom side label includes OmniOn name, product designation and date code.



Pin	Function
1	∨i(+)
2	ON/OFF
3	∨i(-)
4	Vo(-)
5†	SENSE(-)
6†	TRIM
7†	SENSE(+)
8	Vo(+)

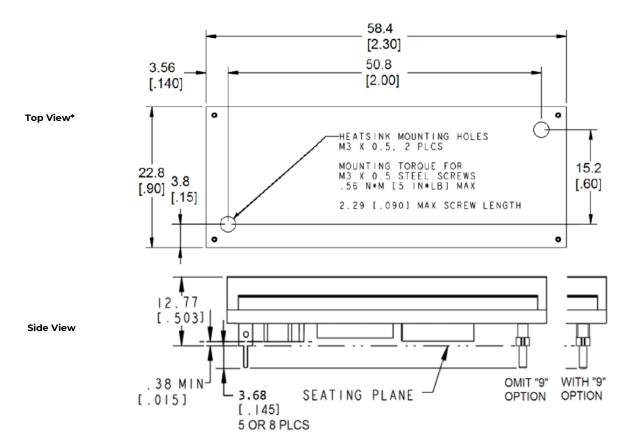


Mechanical Outline for EBVW025A0B–35PHZ (Baseplate version) Through-hole Module

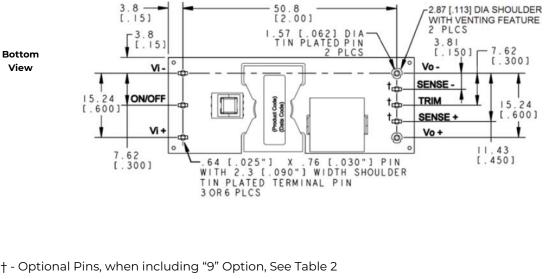
Dimensions are in millimeters and (inches).

Tolerances: x.x mm ±0.5 mm (x.xx in. ± 0.02 in.) [Unless otherwise indicated]

x.xx mm ± 0.25 mm (x.xxx in ± 0.010 in.)



*For optional pin lengths, see Table 2, Device Coding Scheme and Options *Bottom side label includes OmniOn name, product designation and date code.



Pin	Function
1	∨i(+)
2	ON/OFF
3	∨i(-)
4	Vo(-)
5†	SENSE(-)
6†	TRIM
7†	SENSE(+)
8	Vo(+)

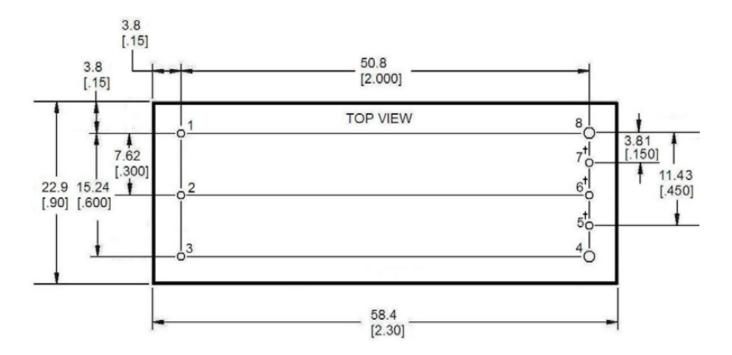
+ - Optional Pins, when including "9" Option, See Table 2



Recommended Pad Layouts

Dimensions are in millimeters and (inches). Tolerances: x.x mm \pm 0.5 mm (x.xx in. \pm 0.02 in.) [Unless otherwise indicated] x.xx mm \pm 0.25 mm (x.xxx in \pm 0.010 in.)

Through-Hole Modules



Pin Number	Pin Name
1*	VIN(+)
2*	ON/OFF
3*	VIN(-)
4*	VOUT(-)
5†	SENSE(-)
6†	TRIM
7†	SENSE(+)
8*	VOUT(+)

† - Optional Pins, See Table 2

Hole and Pad diameter recommendations:

Pin Number	Hole Dia mm [in] Pad Dia mm [in]						
1, 2, 3, 5, 6, 7	1.6 [.063]	2.1 [.083]					
4, 8	2.2 [.087]	3.2 [.126]					



Ordering Information

Please contact your OmniOn Sales Representative for pricing, availability and optional features.

Product Code	Input Voltage	Output Voltage	Output Current	Efficiency	ConnectorType	MSL Rating	Ordering codes
EBVW025A0B41Z	48V (36-75Vdc)	12V	25A	94.7%	Through hole	2a	150024409
EBVW025A0B641Z	48V (36-75Vdc)	12V	25A	94.7%	Through hole	2a	150021953
EBVW025A0B841Z	48V (36-75Vdc)	12V	25A	94.7%	Through hole	2a	150023828
EBVW025A0B41-HZ	48V (36-75Vdc)	12V	25A	94.7%	Through hole	2a	150023485
EBVW025A0B641-HZ	48V (36-75Vdc)	12V	25A	94.7%	Through hole	2a	150029296
EBVW025A0B641-PHZ	48V (36-75Vdc)	12V	25A	94.7%	Through hole	2a	1600086585A
EBVW025A0B9641-HZ	48V (36-75Vdc)	12V	25A	94.7%	Through hole	2a	150021954

Table 1. Device Codes

	Characteristic	Character and position	Definition		
Ratings	Form Factor	E	E= Eight Brick		
	Family Designator	BV	BV = BARRACUDA Series, without PMBus interface		
	Input Voltage	W	W = Wide Range, 36V-75V		
	Output Current	025A0	025AO = 025.0 Amps Maximum Output Current		
	Output Voltage	В	B = 12.0V nominal		
	Trim and Remote Sense Pins	9	Omit = Exclude Trim & Sense Feature and Pins 9 = Include Trim and Sense Feature and Pins (not avail. With P option)		
	Pin Length	8 6	Omit= Default Pin Length shown in mechanical Outline Figures 8 = Pin Length: 2.79 mm ±0.25mm (0.110 in.±0.010 in.) 6 = Pin Length: 3.68 mm ±0.25mm (0.145 in.÷0.010 in.)		
Options	Action following Protective Shutdown	4	Omit = Latching Mode 4 = Auto- restart following shutdown (Overcurrent/Overvoltage)		
	On/Off Logic	1	Omit = Positive Logic 1 = Negative Logic		
	Customer Specific	XY	XY = Customer Specific Modified Code, Omit for Standard Code		
	Optional Features	Р	Omit = Standard open Frame Module P = Forced Droop Output for use in parallel applications (not avail. With 9 option) H= Heat plate, for use with heat sinks or cold-walls		
	RoHS	Z	Omit = RoHS 5/6 Lead Based Solder Used Z = RoHS Complaint		

Contact Us

For more information, call us at +1-877-546-3243 (US) +1-972-244-9288 (Int'l)

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Change History (excludes grammar & clarifications)

Revision	Date	Description of the change
1.4	04/08/2022	Updated as per template, ROHS
1.5	12/07/2023	Updated as per OmniOn template



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